

# MOSFET – Power, Single, N-Channel

40 V, 2.8 mΩ, 110 A

# NTMFS5C450NL

#### **Features**

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- These Devices are Pb-Free and are RoHS Compliant

# MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

| Parameter   |  |                        | Symbol                            | Value          | Unit |
|---|--|------------------------|-----------------------------------|----------------|------|
| Drain-to-Source Voltage   |  |                        | $V_{DSS}$                         | 40             | V    |
| Gate-to-Source Voltage  | )                                      |                        | V <sub>GS</sub>                   | ±20            | V    |
| Continuous Drain  |  | T <sub>C</sub> = 25°C  | I <sub>D</sub>                    | 110            | Α    |
| Current R <sub>θJC</sub> (Notes 1, 3)                                       | Steady                                 | T <sub>C</sub> = 100°C |                                   | 81             |      |
| Power Dissipation   | State                                  | T <sub>C</sub> = 25°C  | $P_{D}$                           | 68             | W    |
| R <sub>θJC</sub> (Note 1)   |  | T <sub>C</sub> = 100°C |                                   | 34             |      |
| Continuous Drain  |  | T <sub>A</sub> = 25°C  | I <sub>D</sub>                    | 27             | Α    |
| Current R <sub>θJA</sub> (Notes 1, 2, 3)                                    | Steady                                 | T <sub>A</sub> = 100°C |                                   | 19             |      |
| Power Dissipation   | State                                  | T <sub>A</sub> = 25°C  | P <sub>D</sub>                    | 3.7            | W    |
| R <sub>θJA</sub> (Notes 1 & 2)  |  | T <sub>A</sub> = 100°C |                                   | 1.6            |      |
| Pulsed Drain Current  | $T_A = 25^{\circ}C$ , $t_p = 10 \mu s$ |                        | I <sub>DM</sub>                   | 740            | Α    |
| Operating Junction and Storage Temperature                                  |  |                        | T <sub>J</sub> , T <sub>stg</sub> | -55 to<br>+175 | °C   |
| Source Current (Body Diode)   |  |                        | IS                                | 76             | Α    |
| Single Pulse Drain-to-Source Avalanche<br>Energy (I <sub>L(pk)</sub> = 7 A) |  |                        | E <sub>AS</sub>                   | 215            | mJ   |
| Lead Temperature for Soldering Purposes (1/8" from case for 10 s)           |  | TL                     | 260                               | °C             |      |

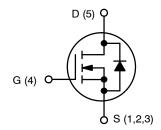
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

## THERMAL RESISTANCE MAXIMUM RATINGS

| Parameter                                   | Symbol          | Value | Unit |
|---|-----------------|-------|------|
| Junction-to-Case - Steady State             | $R_{\theta JC}$ | 2.2   | °C/W |
| Junction-to-Ambient - Steady State (Note 2) | $R_{\theta JA}$ | 41    |      |

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.
- Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

| V <sub>(BR)DSS</sub> | R <sub>DS(ON)</sub> MAX | I <sub>D</sub> MAX |
|----------------------|-------------------------|--------------------|
| 40 V                 | 2.8 mΩ @ 10 V           | 110 4              |
| 40 V                 | 4.4 mΩ @ 4.5 V          | 110 A              |

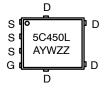


**N-CHANNEL MOSFET** 



DFN5 (SO-8FL) CASE 488AA STYLE 1

#### **MARKING DIAGRAM**



5C450L = Specific Device Code A = Assembly Location

Y = Year

W = Work Week
ZZ = Lot Traceability

# **ORDERING INFORMATION**

See detailed ordering, marking and shipping information on page 5 of this data sheet.

# **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise specified)

| Parameter  | Symbol                              | Test Condition   |                        | Min | Тур  | Max | Unit     |
|--|-------------------------------------|--|------------------------|-----|------|-----|----------|
| OFF CHARACTERISTICS  |                                     |  |                        |     |      |     | •        |
| Drain-to-Source Breakdown Voltage                            | V <sub>(BR)DSS</sub>                | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$  |                        | 40  |      |     | ٧        |
| Drain-to-Source Breakdown Voltage<br>Temperature Coefficient | V <sub>(BR)DSS</sub> /              |  |                        |     | 1.6  |     | mV/°C    |
| Zero Gate Voltage Drain Current                              | I <sub>DSS</sub>                    | $V_{GS} = 0 V$ ,   | T <sub>J</sub> = 25°C  |     |      | 10  | μΑ       |
|  |                                     | $V_{DS} = 40 \text{ V}$  | T <sub>J</sub> = 125°C |     |      | 250 |          |
| Gate-to-Source Leakage Current                               | I <sub>GSS</sub>                    | $V_{DS} = 0 V, V_{G}$  | <sub>S</sub> = 20 V    |     |      | 100 | nA       |
| ON CHARACTERISTICS (Note 4)                                  |                                     |  |                        |     | •    |     | •        |
| Gate Threshold Voltage                                       | V <sub>GS(TH)</sub>                 | $V_{GS} = V_{DS}, I_{D} = 60 \mu A$  |                        | 1.2 |      | 2.0 | V        |
| Threshold Temperature Coefficient                            | V <sub>GS(TH)</sub> /T <sub>J</sub> |  |                        |     | -5.3 |     | mV/°C    |
| Drain-to-Source On Resistance                                | R <sub>DS(on)</sub>                 | V <sub>GS</sub> = 10 V   | I <sub>D</sub> = 40 A  |     | 2.3  | 2.8 | - mΩ     |
|  |                                     | V <sub>GS</sub> = 4.5 V  | I <sub>D</sub> = 40 A  |     | 3.5  | 4.4 |          |
| Forward Transconductance                                     | 9FS                                 | V <sub>DS</sub> = 15 V, I  | <sub>D</sub> = 40 A    |     | 120  |     | S        |
| CHARGES, CAPACITANCES & GATE RE                              | SISTANCE                            |  |                        | I   |      |     | •        |
| Input Capacitance  | C <sub>ISS</sub>                    | V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 20 V   |                        |     | 2100 |     |          |
| Output Capacitance   | C <sub>OSS</sub>                    |  |                        |     | 1000 |     | pF       |
| Reverse Transfer Capacitance                                 | C <sub>RSS</sub>                    |  |                        |     | 42   |     |          |
| Total Gate Charge  | Q <sub>G(TOT)</sub>                 | $V_{GS} = 4.5 \text{ V}, V_{DS} = 20 \text{ V}; I_D = 40 \text{ A}$ $V_{GS} = 10 \text{ V}, V_{DS} = 20 \text{ V}; I_D = 40 \text{ A}$ |                        |     | 16   |     |          |
| Total Gate Charge  | Q <sub>G(TOT)</sub>                 |  |                        |     | 35   |     | 1        |
| Threshold Gate Charge  | Q <sub>G(TH)</sub>                  | V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 20 V; I <sub>D</sub> = 40 A   |                        |     | 4    |     | nC       |
| Gate-to-Source Charge  | Q <sub>GS</sub>                     |  |                        |     | 7    |     | <u> </u> |
| Gate-to-Drain Charge   | Q <sub>GD</sub>                     |  |                        |     | 5    |     |          |
| Plateau Voltage  | V <sub>GP</sub>                     |  |                        |     | 3.2  |     | V        |
| SWITCHING CHARACTERISTICS (Note 5                            | 5)                                  |  |                        |     |      |     |          |
| Turn-On Delay Time   | t <sub>d(ON)</sub>                  |  |                        |     | 11   |     |          |
| Rise Time  | t <sub>r</sub>                      | Voc = 45 V Vr  | oc = 20 V              |     | 110  |     | 1        |
| Turn-Off Delay Time  | t <sub>d(OFF)</sub>                 | $V_{GS} = 4.5 \text{ V}, V_{I}$<br>$I_{D} = 40 \text{ A}, R_{G}$   | $= 1.0 \Omega$         |     | 21   |     | ns       |
| Fall Time  | t <sub>f</sub>                      |  |                        |     | 5    |     | 1        |
| DRAIN-SOURCE DIODE CHARACTERIS                               | STICS                               |  |                        |     |      |     |          |
| Forward Diode Voltage  | $V_{SD}$                            | V <sub>GS</sub> = 0 V,   | T <sub>J</sub> = 25°C  |     | 0.84 | 1.2 |          |
|  |                                     | $I_S = 40 \text{ A}$   | T <sub>J</sub> = 125°C |     | 0.72 |     | V        |
| Reverse Recovery Time  | t <sub>RR</sub>                     |  | 1                      |     | 41   |     |          |
| Charge Time  | t <sub>a</sub>                      | $V_{GS} = 0 \text{ V, } dI_{S}/dt = 100 \text{ A/}\mu\text{s,}$ $I_{S} = 40 \text{ A}$   |                        |     | 19   |     | ns       |
| Discharge Time   | t <sub>b</sub>                      |  |                        |     | 22   |     | 1        |
| Reverse Recovery Charge                                      | Q <sub>RR</sub>                     |  |                        |     | 30   |     | nC       |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Test: pulse width  $\leq 300~\mu s$ , duty cycle  $\leq 2\%$ .

5. Switching characteristics are independent of operating junction temperatures.

#### TYPICAL CHARACTERISTICS

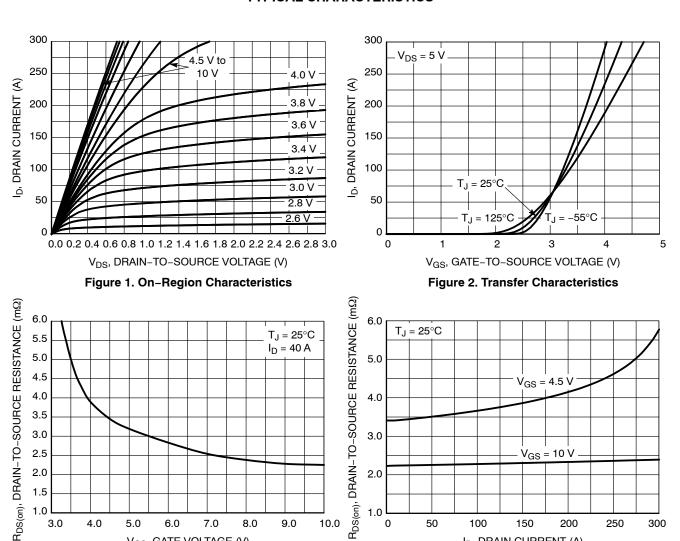


Figure 3. On-Resistance vs. Gate-to-Source

V<sub>GS</sub>, GATE VOLTAGE (V)

6.0

7.0

8.0

9.0

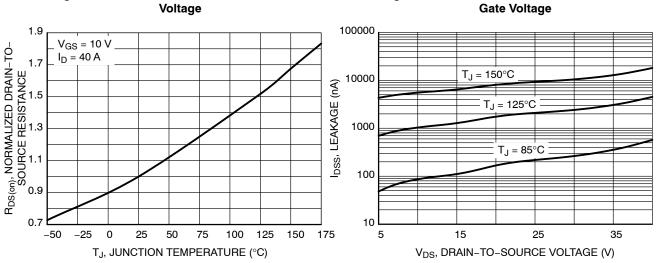
2.0

1.5

3.0

4.0

5.0



10.0

2.0

1.0

50

100

Figure 5. On-Resistance Variation with **Temperature** 

Figure 6. Drain-to-Source Leakage Current vs. Voltage

200

250

300

150

ID, DRAIN CURRENT (A)

Figure 4. On-Resistance vs. Drain Current and

### **TYPICAL CHARACTERISTICS**

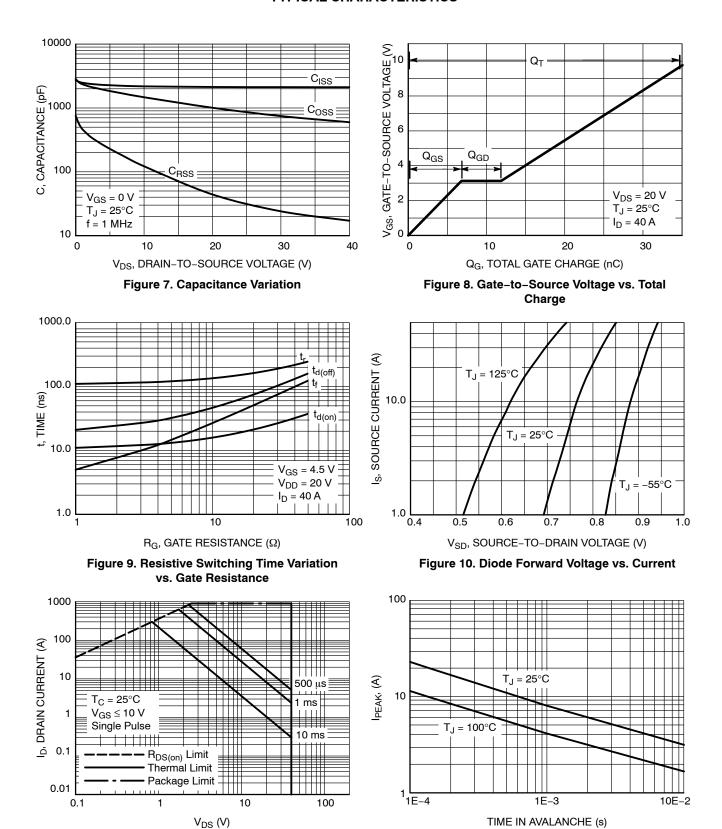


Figure 12. I<sub>PEAK</sub> vs. Time in Avalanche

Figure 11. Safe Operating Area

# **TYPICAL CHARACTERISTICS**

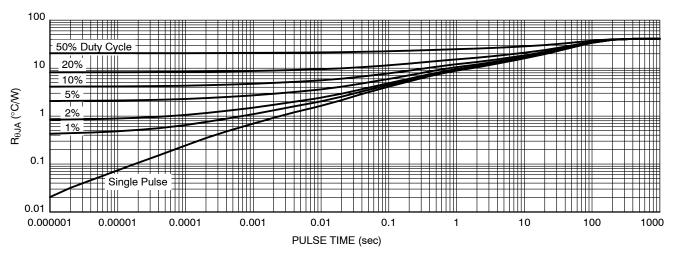


Figure 13. Thermal Characteristics

#### **DEVICE ORDERING INFORMATION**

| Device          | Marking | Package           | Shipping <sup>†</sup> |
|-----------------|---------|-------------------|-----------------------|
| NTMFS5C450NLT1G | 5C450L  | DFN5<br>(Pb-Free) | 1500 / Tape & Reel    |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





DFN5 5x6, 1.27P (SO-8FL) CASE 488AA **ISSUE N** 

**DATE 25 JUN 2018** 

#### NOTES:

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION D1 AND E1 DO NOT INCLUDE
- MOLD FLASH PROTRUSIONS OR GATE BURRS

|     | MILLIMETERS |       |      |  |
|-----|-------------|-------|------|--|
| DIM | MIN         | NOM   | MAX  |  |
| Α   | 0.90        | 1.00  | 1.10 |  |
| A1  | 0.00        |       | 0.05 |  |
| b   | 0.33        | 0.41  | 0.51 |  |
| С   | 0.23        | 0.28  | 0.33 |  |
| D   | 5.00        | 5.15  | 5.30 |  |
| D1  | 4.70        | 4.90  | 5.10 |  |
| D2  | 3.80        | 4.00  | 4.20 |  |
| E   | 6.00        | 6.15  | 6.30 |  |
| E1  | 5.70        | 5.90  | 6.10 |  |
| E2  | 3.45        | 3.65  | 3.85 |  |
| е   | 1.27 BSC    |       |      |  |
| G   | 0.51        | 0.575 | 0.71 |  |
| K   | 1.20        | 1.35  | 1.50 |  |
| L   | 0.51        | 0.575 | 0.71 |  |
| L1  | 0.125 REF   |       |      |  |
| М   | 3.00        | 3.40  | 3.80 |  |
| θ   | 0 °         |       | 12 ° |  |

# **GENERIC MARKING DIAGRAM\***



XXXXXX = Specific Device Code

= Assembly Location Α

= Lot Traceability

Υ = Year W = Work Week

ZZ

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.





**DETAIL** A

SIDE VIEW

\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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|------------------|--------------------------|---|-------------|--|
| DESCRIPTION:     | DFN5 5x6, 1.27P (SO-8FL) |   | PAGE 1 OF 1 |  |

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